



Docket No.: M4065.0454/P454
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Jerome Eldridge et al.

Application No.: 09/929,350

Art Unit: 2815

Filed: August 15, 2001

Examiner: C. C. Chu

For: INTERNAL HYDROGEN SOURCES FOR
HEAT CONDUCTIVE PACKAGING OF
LOW DIELECTRIC CONSTANT
SEMICONDUCTOR CHIPS, AND
METHOD OF PROVIDING HYDROGEN
THEREFOR

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated February 9, 2004 (Paper No. 17), please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 38 of this paper 36/09/2834 JNCXILLA 28062002 041073 09929353

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